

REMARKS

Claims 19-27 and 30-35 are pending. Claims 1-18 and 28-29 have been cancelled. Claims 19, 20, 27 and 31 have been amended. No new matter is introduced.

Rejections under 35 USC § 112, second paragraph

Claims 19-35 have been rejected under 35 USC § 112, second paragraph, for the reasons noted in the Office Action. In particular, the typographical error in claim 19 reciting "non-device pattern surface" twice (e.g., at lines 4 and 5 thereof) has now been corrected to recite a "device pattern surface" together with a "non-device pattern surface" as noted in the **Listing of the Claims** section of this paper.

Also, the term "an epoxy resin protective film" has been amended to "an electrically insulating protective film" – thereby providing proper antecedent basis for the now amended term "the electrically insulating protective film" as noted in the **Listing of the Claims** section of this paper.

In view of the foregoing correction, Applicants submit that claim 19 and claims depending therefrom satisfy the requirements of 35 USC § 112, second paragraph. For at least these reasons, Applicants respectfully request reconsideration of the rejection of claims 19-27 and 30-35 under 35 USC § 112, second paragraph.

Rejection of Claims 1 and 3-8 under 35 USC § 103(a)

Claims 1 and 3-8 are rejected under 35 USC § 103(a) as being unpatentable over U.S. Pat. No. 6,713,856 to Tsai et al. (hereinafter "Tsai") in view of U.S. Pat. No. 5,482,898 (hereinafter "Marrs") for the reasons noted in the Office Action. In view of the cancellation of claims 1 and 3-8, the issue of their rejection is now moot.

Rejection of Claims 1 and 3-10 under 35 USC § 103(a)

Claims 1 and 3-10 are rejected under 35 USC § 103(a) as being unpatentable over U.S. Pat. No. 5,627,106 to Hsu (hereinafter "Hsu") in view of JP5-41478 to Yoshihiro et al. (hereinafter "Yoshihiro") for the reasons noted in the Office Action. In view of the cancellation of claims 1 and 3-10, the issue of their rejection is now moot.

Conclusion

In view of the above, it is respectfully submitted that the application is in condition for allowance and a Notice of Allowance is earnestly solicited.


If any issues remain outstanding, the Examiner is respectfully requested to contact the undersigned attorney so that any remaining issues may be promptly resolved.

No additional fees are believed to be due. However, if an underpayment or overpayment of fees has been made, please debit or credit our Deposit Account No. 19-3935, as needed.

Respectfully submitted,

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Enclosures:
Request for Continued Examination